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(54) Title: METHOD FOR REMOVING UPPER PART OF SACRIFICIAL LAYER, AND SACRIFICIAL SOLUTION AND
ACIDIC AQUEOUS SOLUTION USED THEREFOR

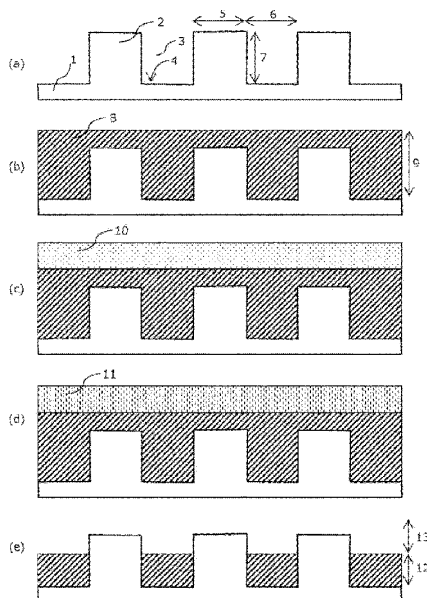


Figure 1

(57) Abstract: [Problem] To provide a method for removing the upper part of a sacrificial layer. [Means for Solution] A method for removing the upper part of a sacrificial layer comprising the following steps: • (1) applying a sacrificial solution comprising a polymer having an acid-dissociable protective group (A) and a solvent (B) above a substrate; • (2) forming a sacrificial layer from the applied sacrificial solution; • (3) subjecting an acidic aqueous solution to contact with the surface of the sacrificial layer; and • (4) applying a remover to the sacrificial layer.

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